



Depleted monolithic CMOS pixel detectors in 150 nm LFoundry technology for the ATLAS Inner Tracker Upgrade

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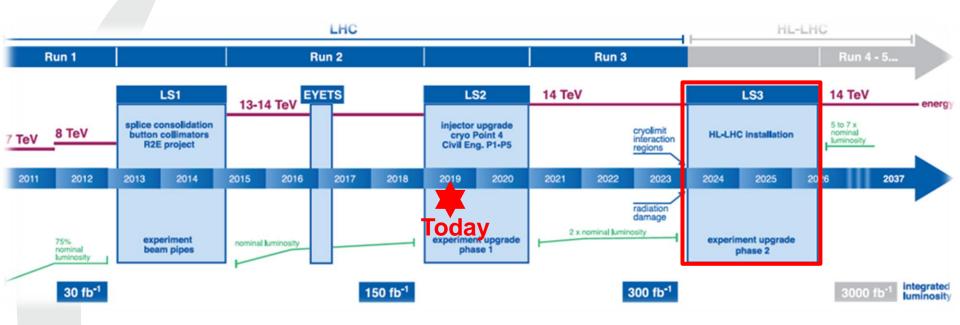
Outline



- ATLAS Inner Tracker (ITk) upgrade
- CMOS sensor option for pixels
- LF-CPIX characterization and beam measurement
- LF-Monopix1 characterization and beam measurement
- Conclusion

LHC / HL-LHC Plan





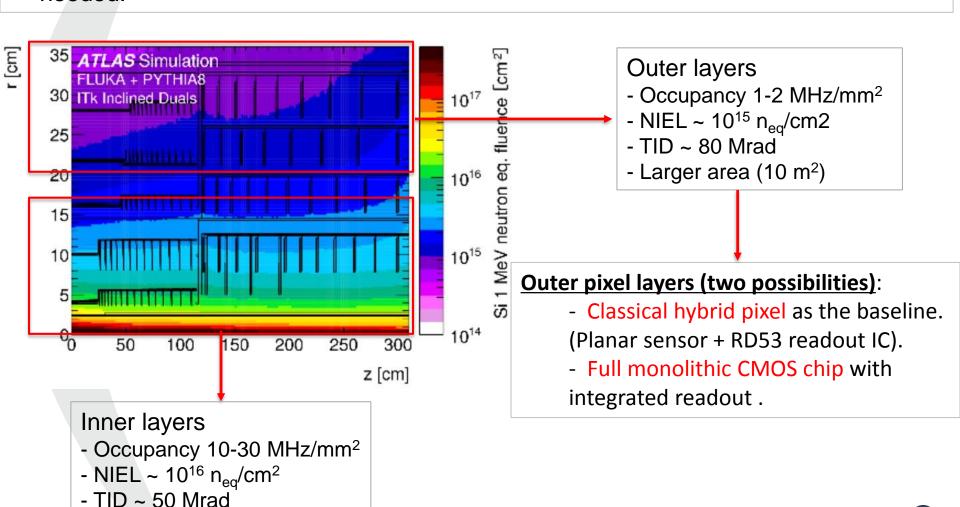
- The High Luminosity Large Hadron Collider (HL-LHC) is foreseen to switch on by 2026 with a center of mass energy of 14 TeV and a peak instantaneous luminosity of 7.5x10³⁴ cm⁻²s⁻¹, five times higher than at present.
- The increased luminosity will result in ~ ten times higher radiation levels and ten times higher data rates.

ATLAS ITk upgrade for HL-LHC

- Larger area (10 m²)



 To match the requirements in terms of radiation hardness, readout speed and granularity at the HL-LHC, the replacement of the present Inner Tracker (ITk) is needed.



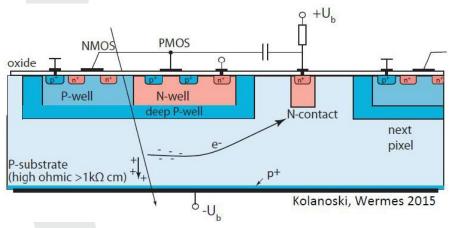
Monolithic CMOS Sensor



- Commercial process (mass production technology).
- No hybridization (reduced material budget and costs, easier procurement).
- Considerable depleted regions in high resistive substrates, fast charge collection by drift

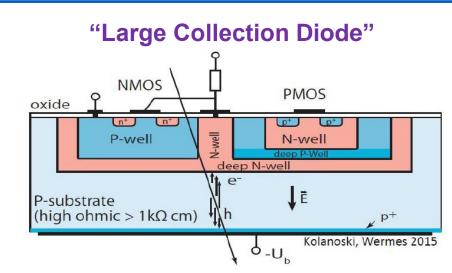
Two design approaches

"Small Collection Diode"



PROS: Small sensor capacitance → low power consumption

CONS: Long drift distances → Less radiation hard



PROS: Short drift distances -> radiation tolerant

CONS: Large sensor capacitance → noise & speed (power) penalties

$$ENC_{thermal}^2 \propto \frac{4}{3} \frac{kT}{g_m} \frac{\mathbf{C_d^2}}{\tau}$$

$$au_{CSA} \propto rac{1}{g_m} rac{\mathbf{C_d}}{C_f}$$

LFoundry technology

LF technology development line



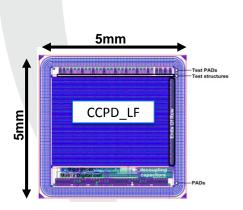
- The process:
 - DeepNW/DeepPW 150nm LF process
 - 7 metal layers
 - High resistivity (> $2k\Omega$.cm)

Characterization results (today!)

2014~2015 Small size demonstrator

CCPD LF

 $33 \times 125 \mu m^2$ pix; 6pix $\rightarrow 2$ FEI4 pix 5×5 mm² IC, **bondable to FE-I4** Bonn / CPPM / KIT

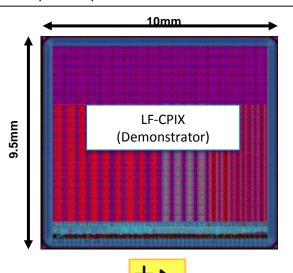




2016~2017 Large size demonstrator

LF-CPIX:

 $50 \times 250 \mu m^2$ pix; diff. pix flavors 10×10 mm²; 2 versions -Guard-Ring-Bonn / CPPM / IRFU



2017~Present Large Monolithic demonstrator

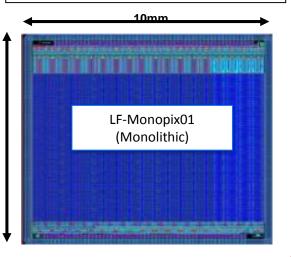
LF-Monopix1:

 $50 \times 250 \mu m^2$ pix

10 × 10 mm² IC

1st full monolithic demonstrator!

Bonn / CPPM / IRFU





LF-CPIX pixel and matrix architecture



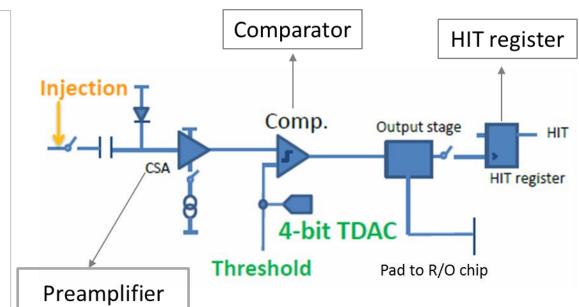
LF-CPIX:

- Testing of sensor diode collection part.
- Testing of analog part of pixels.

Nico Control C

Readout circuitry LF-CPIX

- Process: LFoundry 150 nm
 CMOS process.
- Wafer resistivity: >2kΩ cm.
- Pixel size: 250 μm x 50 μm (can be bump bonded to FE-I4 readout chip).
- Matrix: 23 x 106.
- Flavor: 3 types of CSA



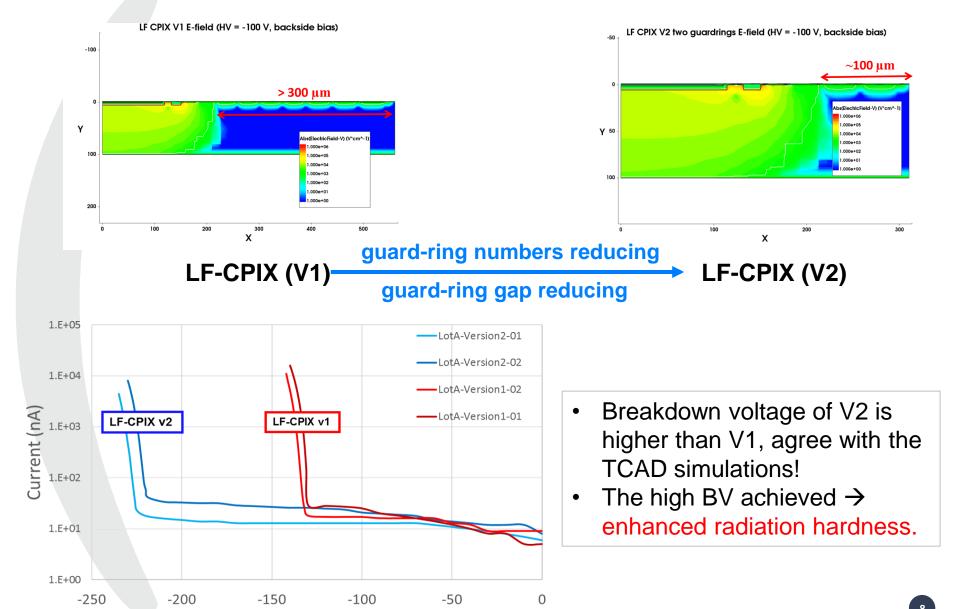
NMOS input

PMOS inputCMOS input

Improved guarding-ring strategy for LF-CPIX

HV Bias (V)

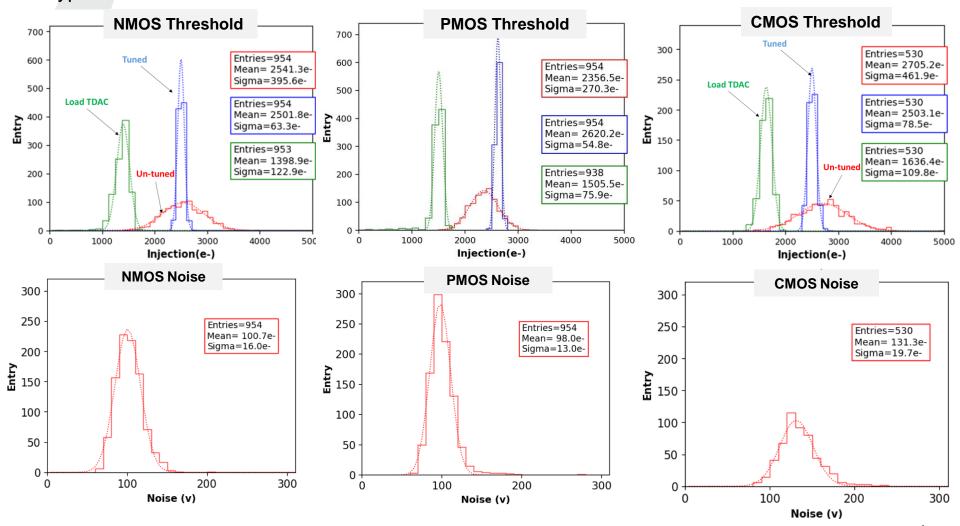




LF-CPIX: Laboratory results before irradiation



- All 3 flavors are working well and the threshold can be tuned, the threshold mean value less than 1500e- can be achieved.
- Typical noise mean value less than 130e-.

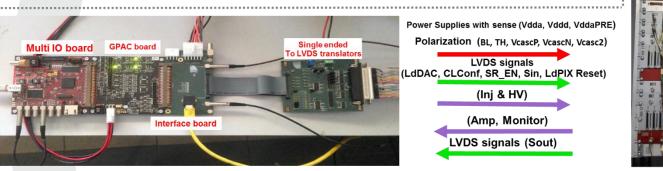


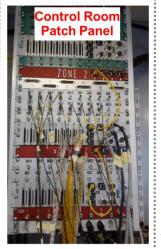
Setup under proton beam @ CERN PS



- Aug → Sep 2017 :
- 24 GeV protons irrad.
- ~150 MRad reached (roughly 2 times the dose expected for the ITk 4th layer).
- Fluence: $2.6 \times 10^{16} \, n_{eq}/cm^2$.

Setup in Control Room





Interface

Setup in Irrad Zone2

Power Supplies with sense (Vdda, Vddd, VddaPRE) LF-CPIX Polarization (BL, TH, VcascP, VcascN, Vcasc2) LVDS signals (LdDAC, CLConf, SR_EN, Sin, LdPIX Reset) (Inj & HV) (Amp, Monitor) LVDS signals (Sout)

LVDS to single ended

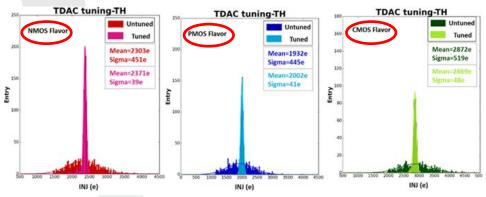
distance of 20m

LF-CPIX testing after irradiation

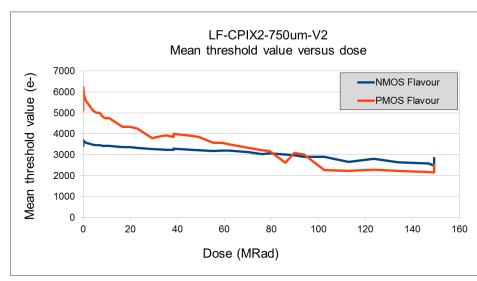


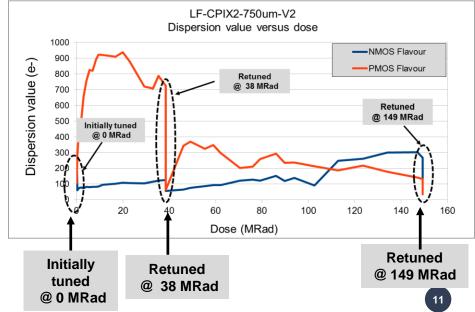
PS irradiation → 150 MRad

- The threshold mean value for both NMOS and PMOS flavors are 2000e- after proton beam irradiation up to 150Mrad.
- The threshold dispersion for the 3 flavors can be tuned to less than 50e- after proton beam irradiation up to 150Mrad.



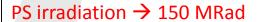
Threshold scan and tuning after radiation

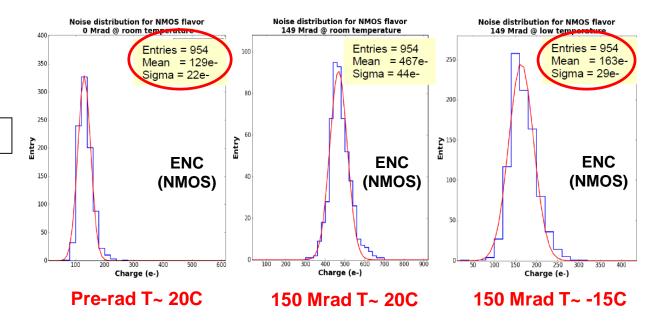




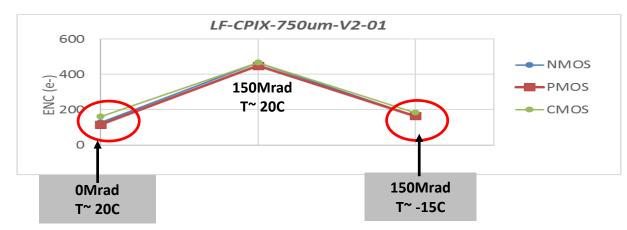
LF-CPIX: Noise after 150 Mrad proton beam irradiation







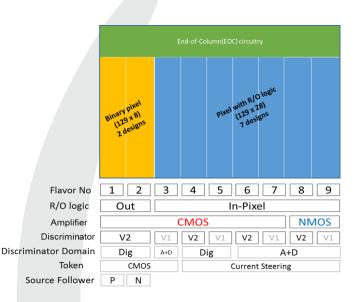
The noise mean values for all flavors are less than 200e- at low temperature after proton beam irradiation up to 150Mrad.

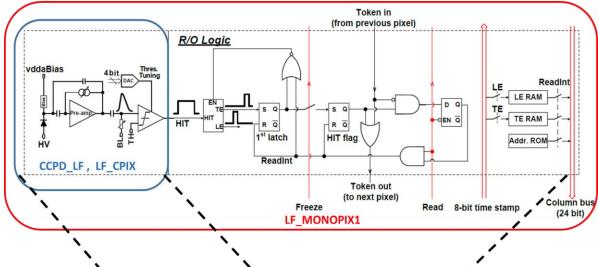


LF-Monopix1: Pixel design



Deep





Preamplifier + Discriminator

- 150nm CMOS process, LFoundry (Resistivity >2kΩ.cm).
- Similar diode and analog front end circuitry design as in LF-CPIX.
- 129 x 36 pixel array (9 sub matrices with different pre-amplifiers, discriminators, R/O concepts ...).
- Column-drain R/O logic (FE-I3 like).
- 40 MHz (up to 160MHz by design) LVDS serial output.

The schematic of LF-MONOPIX1 in-pixel electronics

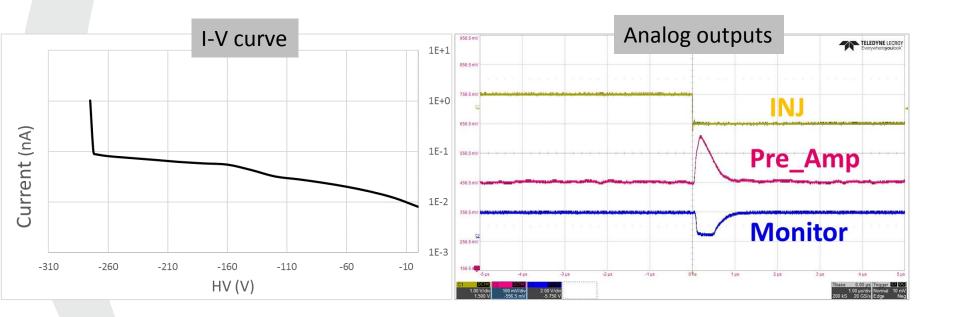
250 um

R/O logic

LF-Monopix1: Laboratory results before irradiation



- The breakdown voltage is around -280V at room temperature, which is an improved value with respect to previous prototype in this technology and matches simulation results.
- Both the preamplifier and discriminator have good response with external test injection



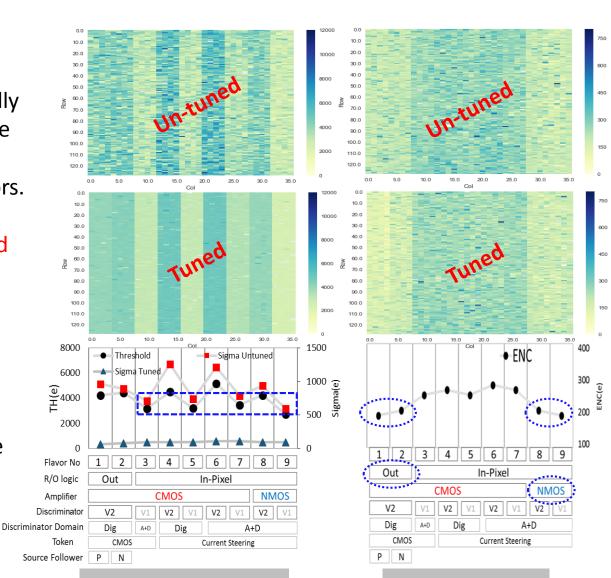
Breakdown ~ -280 V

Responses of the preamplifier and discriminator

LF-Monopix1: Laboratory results before irradiation



- All the flavors of pixels with fully integrated read-out logic can be tuned with a dispersion within 110e~148e depending on flavors. The noise value for different flavors falls between 190 e- and 280 e-.
- V1 discriminator shows better performance on dispersion;
- the NMOS input transistor preamplifiers show lower noise than CMOS flavors.



Threshold mapping

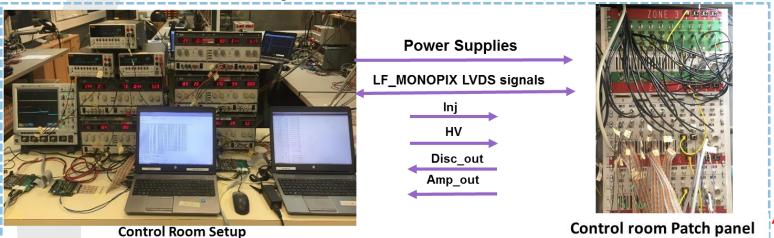
Noise mapping

LF-Monopix1: Setup under proton beam @ CERN PS



- Oct \rightarrow Nov 2018 :
- 24 GeV protons irrad

Setup in Control Room



Setup in Irrad Zone2

Power Supplies

LF_MONOPIX LVDS signals

Inj

HV

Disc_out

Amp_out

IRRAD Zone Patch panel

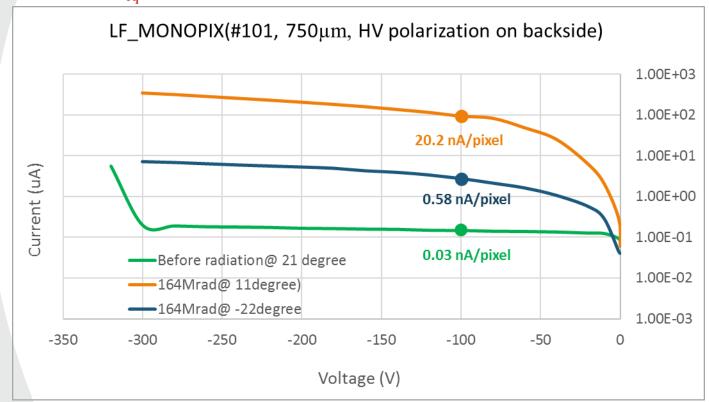
IRRAD Zone table

distance of 20m

Leakage Current: Radiation under PS@CERN



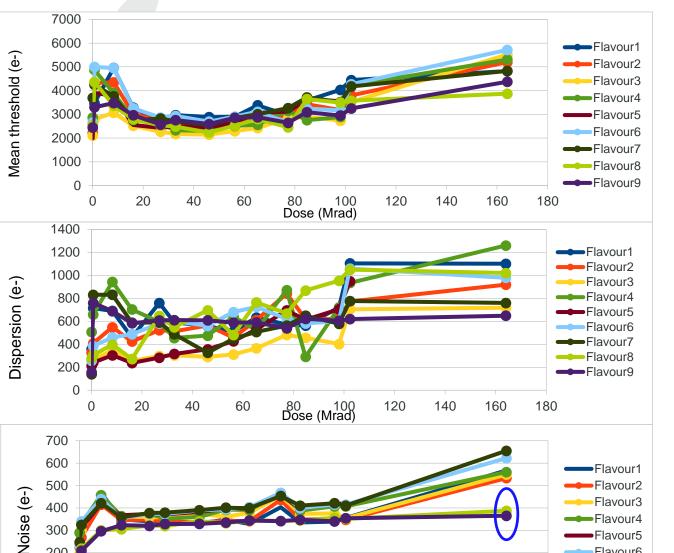
- Oct \rightarrow Nov 2018 :
- 24 GeV protons irrad
- TID~164 MRad reached (roughly 2 times the dose expected for the 4th layer)
- NIEL=2.7 \times 10¹⁶ n_{eq}·cm⁻²



The leakage current increases after irradiations, when the sensor was cooled down to -22 $^{\circ}$ C and the per-pixel leakage appears to be less than 0.58 nA, well below the HL-LHC design requirement (10 nA/pixel).

Mean th, dispersion and noise VS Dose (temp=21° C)





100

Dose (Mrad)

120

140

160

180

300

200

100

0

0

40

20

60

80

LF MONOPIX #101 (750um)

Mean threshold versus dose (Load the tuned TDAC One column each flavor)

Dispersion versus dose (Load the tuned TDAC One column each flavor)

Noise versus dose (Load the tuned TDAC One column each flavor)

Flavour5

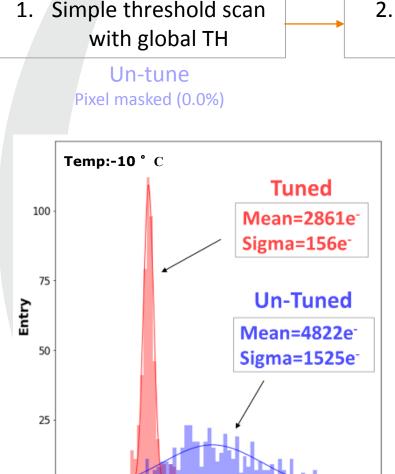
Flavour6

Flavour7

Flavour8

LF_MONOPIX1: threshold tuning (TID=164Mrad)

- Aix*Marseille
 Université
 Initiative d'excellence
 CPPM
- Tested at the end of radiation campaign (Total dose=164Mrad)
- Flavor9: NMOS CSA + V1 Disc



4000

INJ(e)

6000

8000

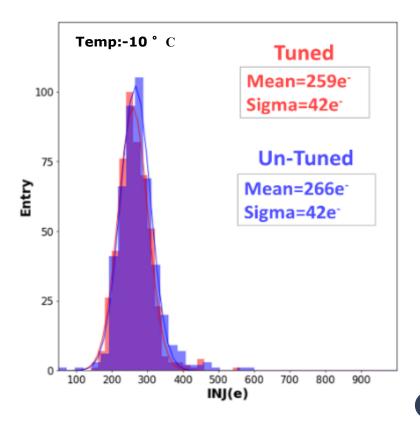
10000

2000

2. TDAC tuning with same global TH

3. Load the TDAC values with lower global TH

Load TDAC
Pixel masked (1.9%)

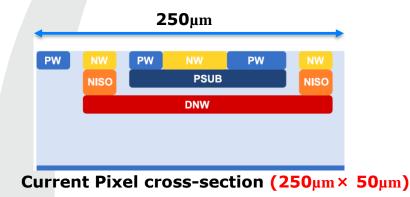


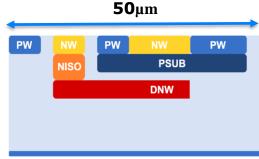
Small pixel approach for LF-MONOPIX2



Motivation:

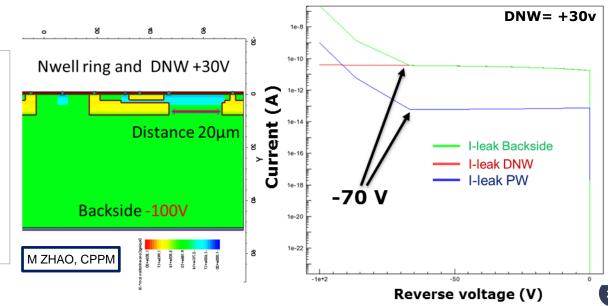
- Increase the granularity → Better track parameter resolution, avoid in-pixel pileup at high particle rates.
- Decrease the sensor capacitance → Resulting in low noise.





reduce the size of the pixel ($50\mu m \times 50\mu m$)

- When the voltage of top Dnwell and Nwell ring is 30V, the BreakDown Voltage is -70V from the substrate, and the current is 50fA from PW and 80pA from DNW.
- The total Voltage potential at 100 V is achieved.



Conclusion & outlook



- Promising results of <u>LF-CPIX</u> were shown in terms of:
 - Good breakdown voltage characteristics (BV below -200V).
 - Radiation hardness of the technology:
 - Tuning of all the 3 flavors possible (threshold dispersion<50e).
 - Limited noise increase after 150 Mrad (noise<200e).
- <u>LF-Monopix1</u>: fully functional demonstrator chip with column drain readout.
 - Good breakdown voltage characteristics (BV below -28 0V).
 - Limited threshold dispersion (can be tuned within 110e~148e depending on flavor).
 - ENC for different flavors is between 190e- to 280 e-.
 - Good irradiation performances:
 - TID=164 MRad and NIEL=2.7 × 10¹⁵ n_{eq}·cm⁻² reached
 - Limited leakage current increase after 164 MRad.
 - Limited ENC increase.
 - The threshold can be tuned down to 2861 e- with a dispersion 156 e-.
- Next step and Outlook
 - Need to understand the radiation effect on different parts of the chip.
 - Need to reduce the pixel size and leakage current (layout optimization).
 - Based on the results of the LF-MONOPIX1, find best strategy for the next demonstrator.

The collaboration works on an improved full size LF_MONOPIX2 and small pixel ICs that could be used in ATLAS ITk outer layer or in other contexts. → target: end of 2019

My PhD activities



Simdet 2016



Annual meeting 2017



Vienna Business School



Secondment at CERN



TWEPP 2018



CV Writing & Job Interview Workshop 2019



My PhD



